

Report No. MCR-22-0258 April 19,2022

RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RA6E1

DEVICE : R7FA6E1XXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$, 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	1 1-\$11)-007 1745 % 5 \$6 \$60der coverage \$95 %		0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



Table. Reliability test results (QFN)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	$\frac{1}{2}$ $\frac{1}$		0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$, 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	1 1-\$11)-1111/ 1/45 1 5 c \$01der coverade \$45 %		0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

•Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 0.08 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term (π T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV)
Ta: Ambient temperature (℃)

π T simplified chart as Ea=0.7 eV												
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

·MTTF (Mean Time To Failure)

$$MTTF = 1/\lambda$$



Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

^{*1.} First four digit

Table. Product list

Table	Table. Product list								
No	Group	Product part number	Package code	No	Group	Product part number	Package code		
1	RA6E1	R7FA6E10D2CFM	PLQP0064K*	51					
2	RA6E1	R7FA6E10F2CFM	PLQP0064K*	52					
3	RA6E1	R7FA6E10D2CFP	PLQP0100K*	53					
4	RA6E1	R7FA6E10F2CFP	PLQP0100K*	54					
5	RA6E1	R7FA6E10D2CNE	PWQN0048K*	55					
6	RA6E1	R7FA6E10F2CNE	PWQN0048K*	56					
7				57					
8				58					
9				59					
10				60					
11				61					
12				62					
13				63		†			
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